

Chapter 4

2D Materials: Molybdenum Disulfide for Electronic and Optoelectronic Devices



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4.1 Introduction

Two-dimensional (2D) materials such as graphene, molybdenum disulfide (MoS_2), tungsten diselenide (WSe_2), black phosphorus, and boron nitride (BN) have attracted much attention due to their extraordinary electronic and optical properties, making them ideal candidates for next-generation electronic and optoelectronic devices [1–4]. In particular, a monolayer of MoS_2 has a direct bandgap of 1.8–1.9 eV [5, 6], making it an ideal candidate for the mentioned applications [1, 2]. Growth processes of 2D MoS_2 include mechanical exfoliation [7–9], chemical vapor deposition (CVD) [5, 6], intercalation-assisted exfoliation [10–13], physical vapor deposition [14, 15], metal organic chemical vapor deposition [16], and a wet chemistry approach involving thermal decomposition of a precursor containing Mo and S [17]. An advantage of CVD growth of MoS_2 is the ability to grow large area films for device fabrication. Molybdenum disulfide films grown using CVD have demonstrated promising results for semiconductor grade material properties, with observed field-effect mobilities around $500 \text{ cm}^2/\text{Vs}$ [18]. During CVD growth, sulfurization of molybdenum-containing precursors such as Mo, MoO_3 , and MoCl_5 is usually performed. In the case of MoO_3 [6] and MoCl_5 [19], the precursors have been powders or ribbons, whereas Mo has been prepared by e-beam evaporation [5] or sputtering [20]. At the Air Force Research Laboratory, we observed the structure properties of MoS_2 films grown by sulfurization of DC magnetron sputtered MoO_3 and Mo precursor films at room temperature. In addition, reduced graphene oxide (rGO), known for increasing layer and domain size of MoS_2 [21, 22], was incorporated in our growth process of MoS_2 . This chapter will be focused on our reported data related to this work.

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4.2 MoS₂ Research

Thin films of metallic Mo and MoO₃ were sputtered on c-face sapphire substrates (diameter of 25.4 mm) using a DC magnetron sputtering system (500 V at 100 mA) at room temperature, with an argon pressure of 0.92 Pa. The thickness of the precursor (3 nm for both Mo and MoO₃) was controlled by manipulating the sputtering so that there were equal amounts of Mo sputtered in the MoO₃ and Mo films. Table 4.1 lists the precursors and sample names. The substrates were ultrasonically cleaned in acetone for 5 minutes prior to deposition of Mo and MoO₃. Following sputtering of Mo and MoO₃ onto the substrates, the precursors were separately placed in the center of the quartz tube (Fig. 4.1). Sulfur powder (2 g) was placed in a ceramic boat, upstream from the Mo and MoO₃ films. Reduced graphene oxide (Sigma-Aldrich) was dispersed in isopropyl alcohol and drop cast on separate sapphire substrates. The rGO samples were air dried before they were placed in the furnace next to the sputtered precursor films of Mo and MoO₃ (with a distance of 5 mm between the precursor and rGO samples). After pumping the furnace down to a vacuum pressure of 667 Pa, the samples were heated to 300 °C at 20 °C/min and held there for 15 minutes. This enabled the removal of any residual water molecules. Next, the

Table 4.1 List of thicknesses used for Mo and MoO₃ precursor films

Sample (<i>r</i> -rGO)	Precursor	Precursor thickness
S1, S1 <i>r</i>	Mo	3 nm
S2, S2 <i>r</i>	MoO ₃	3 nm

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r indicates rGO was used during experiments

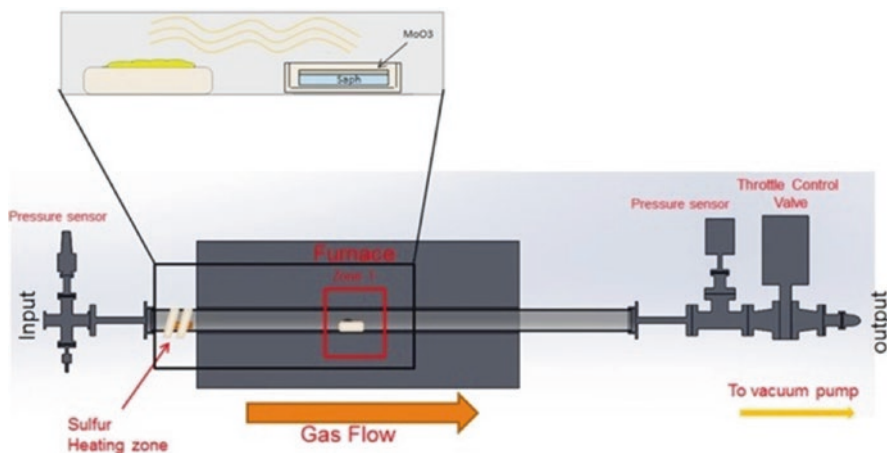


Fig. 4.1 Chemical vapor deposition setup for MoS₂ growth on Al₂O₃ substrates. (Reproduced from Pacley et al. [3], with the permission of the American Vacuum Society)

precursors were heated to 850 °C at a rate of 20 °C/min. As the temperature of the furnace approached 850 °C (around 830 °C), the boat with sulfur was heated to 125 °C using a heating tape. Both the precursors and the sulfur were held at their temperatures for 1 hour, followed by cooling to room temperature. All experiments were performed in an Ar/H₂ environment, with a flow rate of 75 sccm.

Transmission electron microscopy (TEM) imaging of the MoS₂ film cross sections for samples S1 (MoS₂ grown from Mo precursor) and S1r (MoS₂ film grown using Mo precursor with rGO seed) are shown in Fig. 4.2 [3]. The precursor films, MoO₃ and Mo, are both shown in Fig. 4.2a, b [3]. Samples S1 and S1r (Fig. 4.2c, e) show uniform and continuous layer growth of MoS₂ [3]. Both samples have a thickness of 7–8 nm, indicating the rGO used during the CVD growth of sample S1r had no effect on the film thickness. Atomic force microscopy (AFM) showed that samples S1 and S1r had an RMS of 0.360 nm and 2.43 nm (respectively), and the grain size increased from 4.5 nm to 17.7 nm, respectively (see Fig. 4.3a, b) [3]. This increase in the grain size indicated that the rGO played a role in grain growth of the MoS₂. In contrast to the uniform and continuous film growth of samples S1 and S1r, samples S2 (MoO₃ precursor) and S2r (MoO₃ precursor with rGO seed) demonstrated a non-uniform, outward growth of MoS₂ (Fig. 4.2d, f) [3]. It is reported that at 600 °C, MoO₃ reduces to MoO₂ under an H₂ environment [23]. In this research, there was indication that MoO₂ had formed after annealing MoO₃ at 850 °C. X-ray photoelectron spectra (Fig. 4.4a) showed peaks at 229.57 and 232.7 for Mo(IV), which is typical of MoS₂ and MoO₂, and 232.19 and 235.32 for Mo(VI), which is typical of MoO₃. AFM was performed on the same annealed sample (Fig. 4.3c) [3], and we noticed small islands across the substrate. The islands were formed when the sputtered MoO₃ film reduced to MoO₂ during annealing at 850 °C. Consequently, sulfurization of MoO₂ islands caused MoS₂ growth in a Volmer-Weber growth mechanism, which is a result of the film not wetting the substrate [24]. Moser and Levy reported similar growth patterns using sputtering technique to deposit thick MoS₂ films [25].

Figure 4.3d, e shows the grain structures of MoS₂ grown using the sputtered MoO₃ films (S2 and S2r) [3]. The RMS values for these samples were 2.00 nm (S2) and 3.66 nm (S2r), and the grain size increased from 7.9 nm (S2) to 12.2 nm (S2r) when rGO was used during the growth. This correlates well with the data from samples S1 and S1r that suggest rGO promotes grain growth when using sputtered precursor films. There was also a decrease in the film thickness, going from 15 nm (S2) to 7 nm (S2r) when rGO was used during the sulfurization process (Fig. 4.2d, f). Ling et al. [22] report that organic seed promoters (such as PTAS) enable heterogeneous nucleation sites and that the size of the MoS₂ domains is dependent upon the distance of the seed promoter from the precursor. We believe this is what occurred when rGO was used in our experiments involving sputtered Mo and MoO₃ films. However, further investigation needs to be conducted to better understand the kinetics, and mechanism of increasing grain size, when using rGO during the sulfurization sputtered films.

X-ray photoelectron spectroscopy (XPS) was performed for composition and chemistry analysis of the films that were grown in this research. The survey spectra

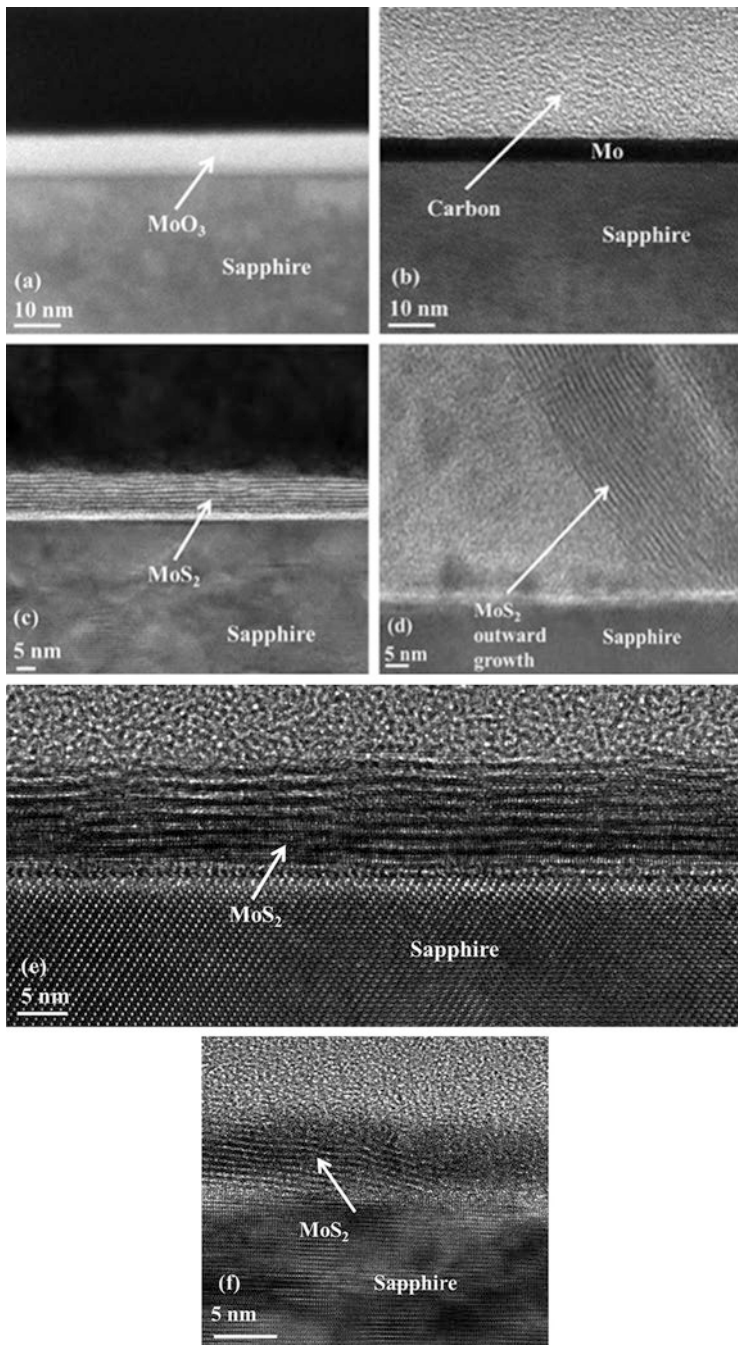


Fig. 4.2 TEM image of (a) MoO_3 precursor film used for MoS_2 growth; (b) Mo precursor film for MoS_2 growth; (c) sample S1 (MoS_2 on sapphire using Mo precursor) showing a layer thickness of 7 nm; (d) sample S2 (MoS_2 on sapphire using a MoO_3 precursor) showing an outward growth of MoS_2 , with a thickness of 15 nm; (e) sample S1r (Mo precursor) using rGO with a measured thickness of 7–8 nm; and (f) sample S2r (MoO_3) using rGO with a thickness of 7 nm. (Reproduced from Pacley et al. [3], with the permission of the American Vacuum Society)

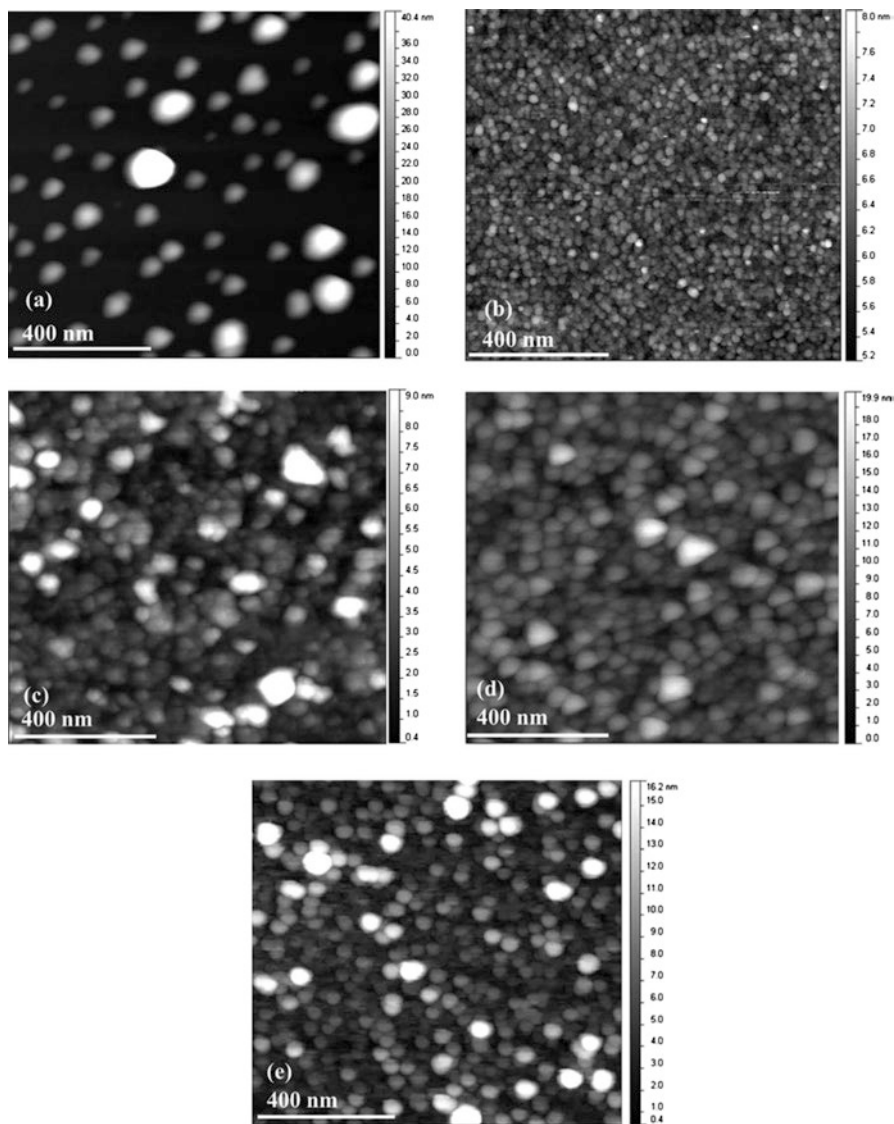


Fig. 4.3 AFM surface topography ($1 \times 1 \mu\text{m}$) for (a) MoO_3 precursor that was heated to 850°C forming MoO_2 islands; (b) sample S1 (Mo precursor) showing a dense film of MoS_2 with a grain size of 4.4 nm; (c) MoS_2 sample S2 (MoO_3 precursor) with a grain size of 7.9 nm; (d) MoS_2 of MoS_2 , with a thickness of 15 nm; (e) sample S1r (Mo precursor) using rGO with a measured thickness of 7–8 nm; and (f) sample S2r (MoO_3) using rGO with a thickness of 7 nm. (Reproduced from Pacley et al. [3], with the permission of the American Vacuum Society)

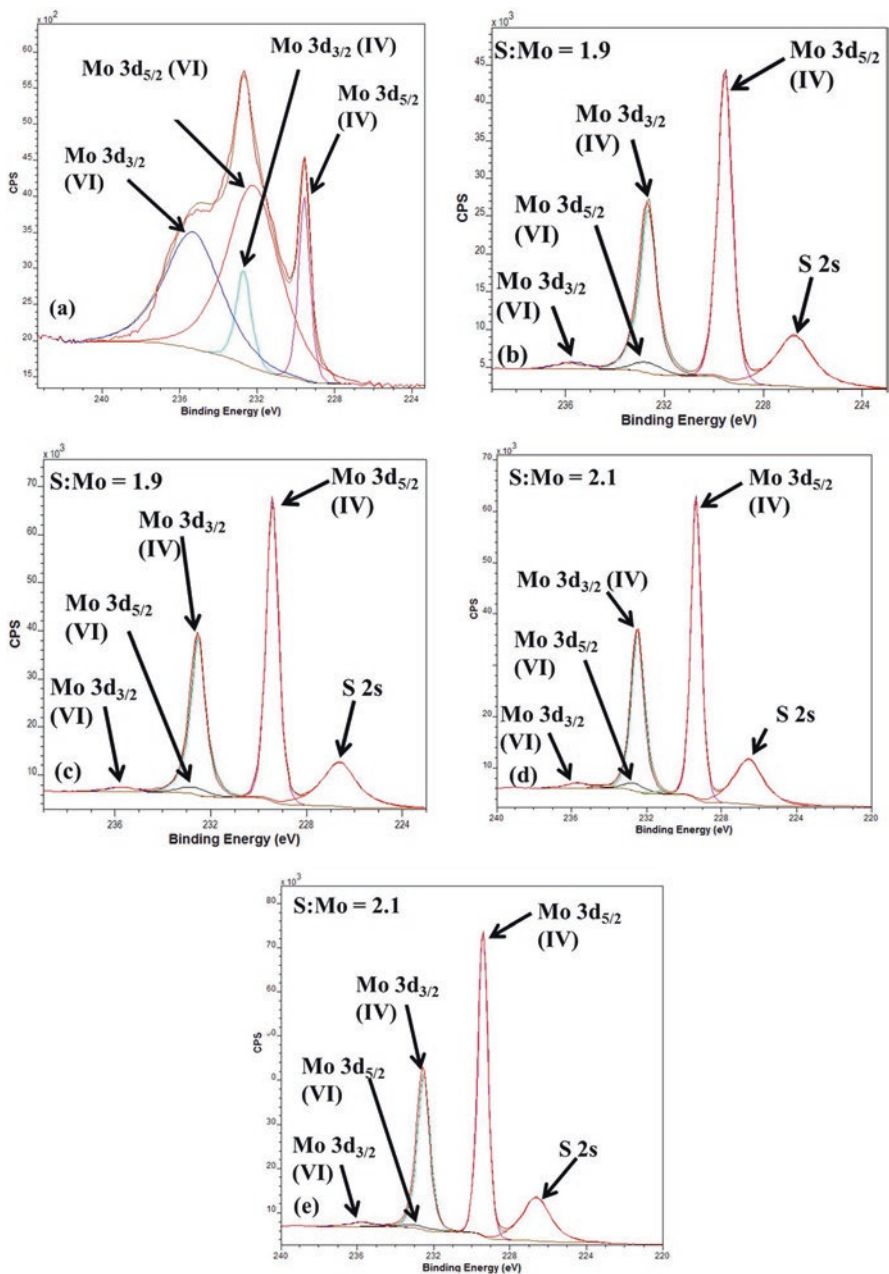


Fig. 4.4 XPS spectra of annealed MoO₃, MoS₂ films S1(MoS₂ using Mo precursor), S2 (MoS₂ using MoO₃ precursor) and S2r (MoS₂ using MoO₃ precursor and rGO). The annealed MoO₃ (a) shows Mo(IV) peaks which are indicative of MoO₃ and Mo(VI) peaks that occur when MoO₃ is present. Both (b) and (c) show spectra for samples S1 and S2, respectively, having a stoichiometric structure. In (d) and (e), the stoichiometry has increased for samples S1r and S2r, respectively, indicating the rGO played a role in increasing the stoichiometry. (Reproduced from Pacey et al. [3], with the permission of the American Vacuum Society)

(not shown) from sulfurized thin films of samples S1/S1 r and S2/S2 r showed peaks from Mo and S, as expected. As mentioned previously, Fig. 4.4a shows the spectra for annealed MoO₃ [3]. The influence of the rGO on MoS₂ stoichiometry was analyzed by comparing the S:Mo ratios obtained from the XPS spectra. The MoS₂ films grown from samples S1 and S1 r had S:Mo ratios of 1.9 and 2.1, respectively (see Fig. 4.4b, d). Samples S2 and S2 r demonstrated the same respective S:Mo ratios of 1.9 and 2.1 (see Fig. 4.4c, e). The apparent improvement in the film stoichiometry is most likely a result of the Mo:S averaging over large spot size analysis area in XPS, which is orders of magnitude larger when compared to the average grain sizes of synthesized MoS₂ films. The presence of the rGO helped to increase the MoS₂ grain size areas and correspondingly decrease contributions of photoelectrons escaped from the grain boundary areas.

Curve fits to the Mo 3d doublets for all of the samples revealed two populations of Mo atoms. The Mo 3d_{5/2} peak at 229.8 eV and Mo 3d_{3/2} peak at 232.9 eV reveal the presence of Mo(IV), with a binding energy typical of MoS₂ or MoO₂ [26]. The Mo 3d_{5/2} peak at 232.7 eV and Mo 3d_{3/2} peak at 235.8 eV indicate the presence of Mo(VI), with a binding energy typical of MoO₃ [27]. This suggests that there is likely some MoO₂ present at the surface or at grain boundaries within the films. However, the intensity for both the Mo(IV) and Mo(VI) peaks are so low, that the presence of MoO₂ and MoO₃ is negligible.

4.3 Conclusion

The influence of metallic Mo and MoO₃ thin-film precursors on the structure of MoS₂ films grown by CVD was investigated. TEM established that rGO did not have an impact on the MoS₂ film thickness for sputtered Mo but that it was responsible for the increase in the grain size. We also observed an increase in the grain size when rGO was used during sulfurization of sputtered MoO₃. Reports demonstrate that seed promoters diffuse onto growth substrates, acting as nucleation sites for MoS₂ growth. In addition, the size of the MoS₂ domains is dependent upon the distance between the seed promoter and the growth substrate. In conclusion, sputtered Mo precursor films produce better uniformity and continuous MoS₂ films, making these nanocrystalline films potentially applicable for electronic and optoelectronic devices.

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